# P4C165 ULTRA HIGH SPEED 8K x 8 RESETTABLE STATIC CMOS RAM

## FEATURES

- Full CMOS, 6T Cell
- High Speed (Equal Access and Cycle Times) – 15/20/25 ns (Commercial)
  - 20/25/35 (Industrial)
- Low Power Operation
- Chip Clear Function

- Output Enable and Dual Chip Enable Control Functions
- Single 5V±10% Power Supply
- Common Data I/O
- Fully TTL Compatible Inputs and Outputs
- Standard Pinout (JEDEC Approved)
  28-Pin Plastic DIP (300 mil)

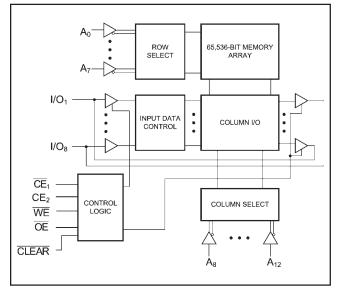
## DESCRIPTION

The P4C165 is a 65,536-bit ultra high-speed static RAM organized as  $8K \times 8$ . The RAM features a reset control to enable clearing all words to zero within two cycle times. The CMOS memory requires no clocks or refreshing and has equal access and cycle times. Inputs are fully TTL-compatible. The RAM operates from a single  $5V\pm10\%$  tolerance power supply.

Access times as fast as 15 nanoseconds are available, permitting greatly enhanced system operating speeds. In full standby mode with CMOS inputs, power consumption is only 5.5 mW for the P4C165.

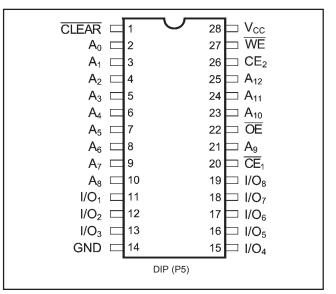
The P4C165 is available in a 28-pin 300 mil DIP.

## FUNCTIONAL BLOCK DIAGRAM





## PIN CONFIGURATION



Document # SRAM117 Rev OR

P4C165

### **MAXIMUM RATINGS(1)**

Symbol	Parameter	Value	Unit
V <sub>cc</sub>	Power Supply Pin with Respect to GND	–0.5 to +7	V
V	Terminal Voltage with Respect to GND (up to 7.0V)	–0.5 to V <sub>cc</sub> +0.5	V
T <sub>A</sub>	Operating Temperature	-55 to +125	°C

### RECOMMENDED OPERATING TEMPERATURE AND SUPPLY VOLTAGE

Grade(2)	arade(2) Ambient Temperature		V <sub>cc</sub>
Commercial	0°C to +70°C	0V	5.0V ± 10%
Industrial	–40°C to +85°C	0V	5.0V ± 10%

Symbol	Parameter	Value	Unit
T <sub>BIAS</sub>	Temperature Under Bias	–55 to +125	°C
T <sub>STG</sub>	Storage Temperature	–65 to +150	°C
Ρ <sub>τ</sub>	Power Dissipation	1.0	W
I <sub>OUT</sub>	DC Output Current	50	mA

### CAPACITANCES<sup>(4)</sup>

 $V_{cc} = 5.0V, T_{A} = 25^{\circ}C, f = 1.0MHz$ 

Symbol	Parameter	Conditions	Тур.	Unit	
C <sub>IN</sub>	Input Capacitance	$V_{IN} = 0V$	5	pF	
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 0V	7	pF	

### DC ELECTRICAL CHARACTERISTICS

Over recommended operating temperature and supply voltage<sup>(2)</sup>

Cumhal	Deveneter	Test Conditions	P40	P4C165		
Symbol	Parameter	Test Conditions	Min	Мах	Unit	
V <sub>IH</sub>	Input High Voltage		2.2	V <sub>cc</sub> +0.5	V	
V <sub>IL</sub>	Input Low Voltage		-0.5(3)	0.8	V	
V <sub>HC</sub>	CMOS Input High Voltage		V <sub>cc</sub> -0.2	V <sub>cc</sub> +0.5	V	
V <sub>LC</sub>	CMOS Input Low Voltage		-0.5(3)	0.2	V	
V <sub>CD</sub>	Input Clamp Diode Voltage	$V_{\rm cc}$ = Min., I <sub>IN</sub> = -18 mA		-1.2	V	
V <sub>ol</sub>	Output Low Voltage (TTL Load)	$I_{oL}$ = +8 mA, $V_{cc}$ = Min.		0.4	V	
V <sub>oh</sub>	Output High Voltage (TTL Load)	$I_{OH} = -4 \text{ mA}, V_{CC} = \text{Min}.$	2.4		V	
I <sub>U</sub>	Input Leakage Current	$V_{cc}$ = Max. $V_{IN}$ = GND to $V_{cc}$ Ind./Com'l.	-5	+5	μA	
I <sub>LO</sub>	Output Leakage Current	$V_{cc} = Max., \overline{CE} = V_{IH},$ $V_{OUT} = GND \text{ to } V_{cc}$ Ind./Com'l.	5	+5	μA	
I <sub>SB</sub>	Standby Power Supply Current (TTL Input Levels)	$\label{eq:cell} \hline \overrightarrow{CE} \geq V_{IH} \text{ or } \\ CE_2 \leq V_{IL}, V_{CC} = Max \qquad Ind./Com'l. \\ f = Max., Outputs Open \qquad \qquad$		30	mA	
I <sub>SB1</sub>	Standby Power Supply Current (CMOS Input Levels)	$\label{eq:constraint} \begin{array}{ c c c } \hline \overline{CE} \geq V_{HC} \mbox{ or } \\ CE_2 \leq V_{LC},  V_{CC} \mbox{=} \mbox{ Max } \\ f \mbox{=} \mbox{ 0, Outputs Open } \\ V_{IN} \leq V_{LC} \mbox{ or } V_{IN} \geq V_{HC} \end{array} \qquad \mbox{ Ind./Com'l.}$		15	mA	

n/a = Not Applicable

#### Notes:

- Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to MAXIMUM rating conditions for extended periods may affect reliability.
- 2. Extended temperature operation guaranteed with 400 linear feet per minute of air flow.
- 3. Transient inputs with V<sub>IL</sub> and I<sub>IL</sub> not more negative than -3.0V and -100mA, respectively, are permissible for pulse widths up to 20 ns.
- 4. This parameter is sampled and not 100% tested.

## POWER DISSIPATION CHARACTERISTICS VS. SPEED

Symbol	Parameter	Temperature Range	-15	-20	-25	-35	Unit
I <sub>cc</sub> Dynamic Operating Current*	Dynamic Operating Current*	Commercial	160	155	150	N/A	mA
		Industrial	N/A	160	155	150	mA

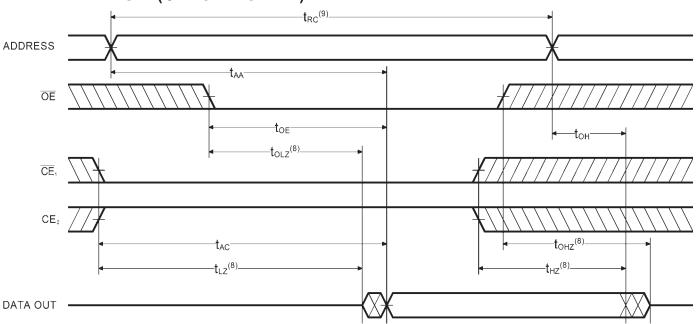
 $*V_{cc} = 5.5V.$  Tested with outputs open. f = Max. Switching inputs are 0V and 3V.  $\overline{CE}_1 = V_{IL}, CE_2 = V_{IH}, \overline{OE} = V_{IH}$ 

## AC ELECTRICAL CHARACTERISTICS—READ CYCLE

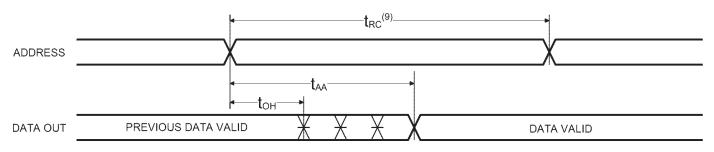
(V $_{\rm CC}$  = 5V ± 10%, All Temperature Ranges)  $^{\!\rm (2)}$ 

Sym.	Parameter	-1	5	-2	20	-25		-35		Unit
Oyin.			Мах	Min	Max	Min	Мах	Min	Мах	onne
t <sub>RC</sub>	Read Cycle Time	15		20		25		35		ns
t <sub>AA</sub>	Address Access Time		15		20		25		35	ns
t <sub>AC</sub>	Chip Enable Access Time		15		20		25		35	ns
t <sub>oh</sub>	Output Hold from Address Change	3		3		3		3		ns
t <sub>LZ</sub>	Chip Enable to Output in Low Z	2		2		2		2		ns
t <sub>HZ</sub>	Chip Disable to Output in High Z		8		8		10		15	ns
t <sub>oe</sub>	Output Enable Low to Data Valid		9		10		13		18	ns
t <sub>olz</sub>	Output Enable Low to Low Z	2		2		2		2		ns
t <sub>ohz</sub>	Output Enable High to High Z		9		9		12		15	ns
t <sub>PU</sub>	Chip Enable to Power Up Time	0		0		0		0		ns
t <sub>PD</sub>	Chip Disable to Power Down Time		15		20		20		20	ns

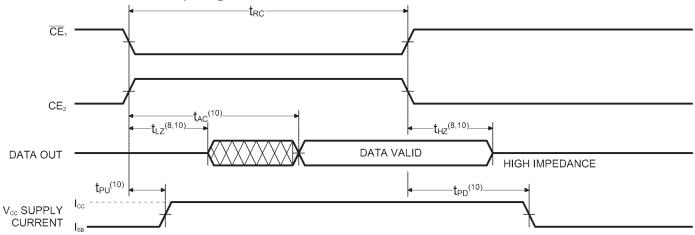
## READ CYCLE NO. 1 (OE CONTROLLED)<sup>(5)</sup>



### READ CYCLE NO. 2 (ADDRESS CONTROLLED)<sup>(5,6)</sup>



## READ CYCLE NO. 3 (CE, CONTROLLED)<sup>(5,7,10)</sup>



#### Notes:

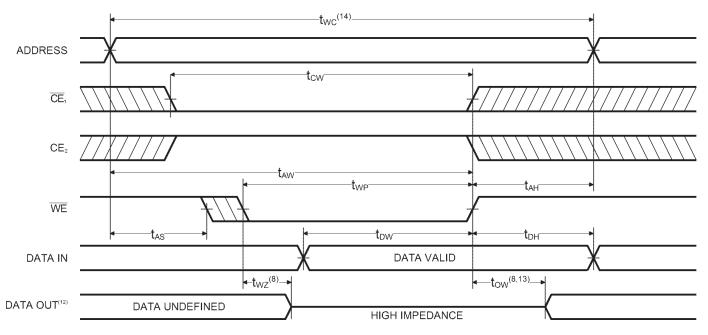
- 5. WE is HIGH for READ cycle.
- 6.  $\overline{CE}_1$  is LOW,  $CE_2$  is HIGH and  $\overline{OE}$  is LOW for READ cycle. 7. ADDRESS must be valid prior to, or coincident with  $\overline{CE}_1$  transition LOW and CE<sub>2</sub> transition HIGH.
- 8. Transition is measured ± 200 mV from steady state voltage prior to change, with loading as specified in Figure 1. This parameter is sampled and not 100% tested.
- 9. READ Cycle Time is measured from the last valid address to the first transitioning address.
- 10. Transitions caused by a chip enable control have similar delays irrespective of whether  $\overline{CE}_1$  or  $CE_2$  causes them.

## AC CHARACTERISTICS—WRITE CYCLE

(V<sub>cc</sub> = 5V  $\pm$  10%, All Temperature Ranges)<sup>(2)</sup>

Sum	Parameter	-1	5	-20		-25		-35		Unit
Sym.	Falameter	Min	Max	Min	Max	Min	Мах	Min	Мах	Onit
t <sub>wc</sub>	Write Cycle Time	15		20		25		35		ns
t <sub>cw</sub>	Chip Enable Time to End of Write	12		15		18		25		ns
t <sub>AW</sub>	Address Valid to End of Write	12		15		18		25		ns
t <sub>AS</sub>	Address Set-up Time	0		0		0		0		ns
t <sub>wP</sub>	Write Pulse Width	12		15		18		20		ns
t <sub>AH</sub>	Address Hold Time	0		0		0		0		ns
t <sub>DW</sub>	Data Valid to End of Write	9		11		13		15		ns
t <sub>DH</sub>	Date Hold Time	0		0		0		0		ns
t <sub>wz</sub>	Write Enable to Output in High Z		7		8		10		14	ns
t <sub>ow</sub>	Output Active from End of Write	3		3		3		3		ns

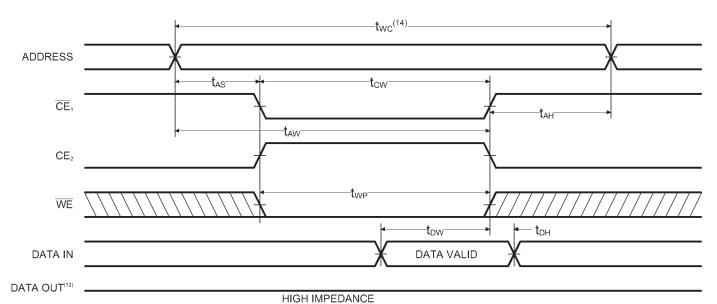
## WRITE CYCLE NO. 1 (WE CONTROLLED)(11)



#### Notes:

- 11.  $\overrightarrow{CE}_1$  and  $\overrightarrow{WE}$  must be LOW, and  $\overrightarrow{CE}_2$  HIGH for WRITE cycle. 12.  $\overrightarrow{OE}$  is LOW for this WRITE cycle to show  $t_{WZ}$  and  $t_{OW}$ . 13. If  $\overrightarrow{CE}_1$  goes HIGH, or  $\overrightarrow{CE}_2$  goes LOW, simultaneously with  $\overrightarrow{WE}$  HIGH, the output remains in a high impedance state.
- 14. Write Cycle Time is measured from the last valid address to the first transitioning address.

## TIMING WAVEFORM OF WRITE CYCLE NO. 2 (CE CONTROLLED)<sup>(11)</sup>

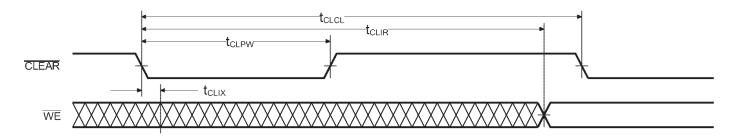


AC CHARACTERISTICS—CLEAR CYCLE

 $(V_{CC} = 5V \pm 10\%, All Temperature Ranges)^{(2)}$ 

Sym.	Parameter		-15		-20		-25		-35	
		Min	Мах	Min	Мах	Min	Мах	Min	Max	Unit
t <sub>CLCL</sub>	CLEAR Cycle Time	30		40		50		70		ns
t <sub>CLPW</sub>	CLEAR Pulse Width	12		15		15		20		ns
t <sub>CLIX</sub>	CLEAR Low to Inputs Don't Care	0		0		0		0		ns
t <sub>CLIR</sub>	CLEAR Low to Inputs Recognized		30		40		50		70	ns

## TIMING WAVEFORM OF CLEAR CYCLE

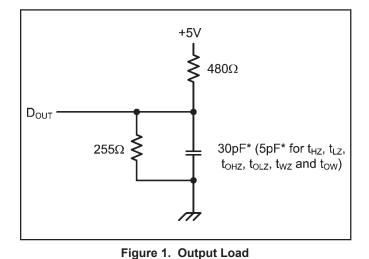


### AC TEST CONDITIONS

Input Pulse Levels	GND to 3.0V
Input Rise and	
Fall Times	3ns
Input Timing	
Reference Level	1.5V
Output Timing	
Reference Level	1.5V
Output Load	See Figures 1 and 2

## **TRUTH TABLE**

Mode	CLEAR	$\overline{CE}_1$	CE <sub>2</sub>	ŌĒ	WE	I/O	Power
Reset	L	Х	Х	Х	Х		Active
Standby	Н	Н	Х	Х	Х	High Z	Standby
Standby	Н	Х	L	Х	Х	High Z	Standby
Output Disabled	Н	L	Н	Н	Н	High Z	Active
Read	Н	L	Н	L	Н	D <sub>OUT</sub>	Active
Write	Н	L	Н	Х	L	High Z	Active



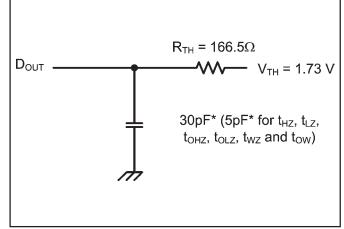


Figure 2. Thevenin Equivalent

\* including scope and test fixture.

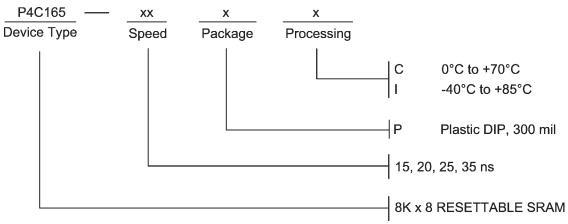
#### Note:

Because of the ultra-high speed of the P4C165, care must be taken when testing this device; an inadequate setup can cause a normal functioning part to be rejected as faulty. Long high-inductance leads that cause supply bounce must be avoided by bringing the V<sub>cc</sub> and ground planes directly up to the contactor fingers. A 0.01  $\mu F$  high frequency capacitor is also required between V<sub>cc</sub> and ground. To avoid signal

reflections, proper termination must be used; for example, a  $50\Omega$  test environment should be terminated into a  $50\Omega$  load with 1.73V (Thevenin Voltage) at the comparator input, and a  $116\Omega$  resistor must be used in series with  $D_{\text{OUT}}$  to match  $166\Omega$  (Thevenin Resistance).



## **ORDERING INFORMATION**

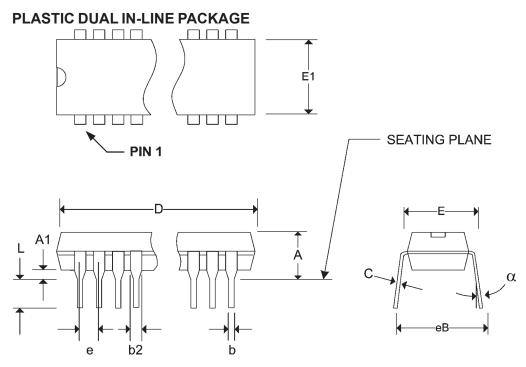


### SELECTION GUIDE

The P4C165 is available in the following temperature, speed and package options.

Temperature	Dookogo	Speed							
Range	Package	15	20	25	35				
Commercial	Plastic DIP	-15PC	-20PC	-25PC	-35PC				
Industrial	Plastic DIP	-15PI	-20PI	-25PI	-35PI				

Pkg #	Р	<sup>2</sup> 5
# Pins	28 (300 mil)	
Symbol	Min	Max
Α	-	0.210
A1		-
b	0.014	0.023
b2	0.045	0.070
С	0.008	0.014
D	1.345	1.400
E1	0.270	0.300
E	0.300	0.380
е	0.100 BSC	
eB	-	0.430
L	0.115	0.150
α	0°	15°



#### Document # SRAM117 Rev OR

## REVISIONS

	DOCUMENT NUMBER:SRAM117DOCUMENT TITLE:P4C165 ULTRA HIGH SPEED 8K x 8 RESETTABLE STATIC CMOS RAM		
REV.	ISSUE DATE	ORIG. OF CHANGE	DESCRIPTION OF CHANGE
OR	Oct-05	JDB	New Data Sheet